

US00D491899S1

(12) **United States Design Patent** (10) **Patent No.:** **US D491,899 S**
Yagi (45) **Date of Patent:** **** Jun. 22, 2004**

(54) **LIGHT EMITTING DIODE**

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- (73) Assignee: **Nichia Corporation, Anan (JP)**
- (**) Term: **14 Years**

- (21) Appl. No.: **29/191,319**
- (22) Filed: **Oct. 7, 2003**

Related U.S. Application Data

- (62) Division of application No. 29/161,015, filed on May 22, 2002.
- (51) **LOC (7) Cl.** **13-03**
- (52) **U.S. Cl.** **D13/180**
- (58) **Field of Search** D13/104, 114, D13/180, 182; D26/37; 174/52.2; 257/79, 88, 89, 93-96, 91, 98, 99, 100, 432, 433, 434, 678, 684, 698; 313/499, 500; 362/35, 226, 249, 287, 294, 800

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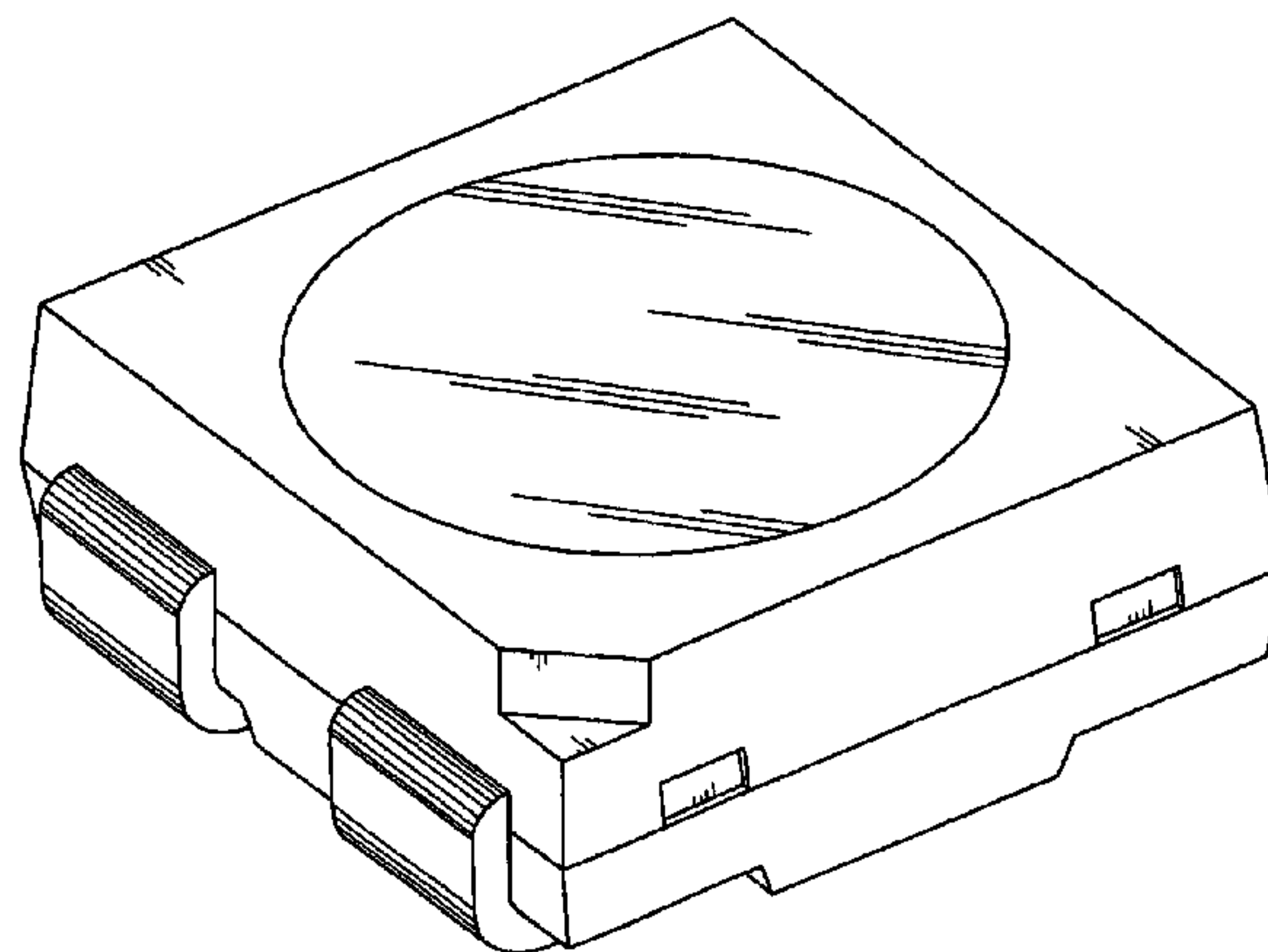
(57) **CLAIM**

I claim the ornamental design for a light emitting diode, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a light emitting diode showing my new design;
FIG. 2 is a top plan view of the light emitting diode according to the embodiment of FIG. 1;
FIG. 3 is a left side elevational view of the light emitting diode according to the embodiment of FIG. 1;
FIG. 4 is a front elevational view of the light emitting diode according to the embodiment of FIG. 1;
FIG. 5 is a right side elevational view of the light emitting diode according to the embodiment of FIG. 1;
FIG. 6 is a bottom plan view of the light emitting diode according to the embodiment of FIG. 1;
FIG. 7 is a rear elevational view of the light emitting diode according to the embodiment of FIG. 1;
FIG. 8 is a top plan view of the light emitting diode according to another embodiment of my new design;
FIG. 9 is a left side elevational view of the light emitting diode according to the embodiment of FIG. 8;
FIG. 10 is a front elevational view of the light emitting diode according to the embodiment of FIG. 8;
FIG. 11 is a right side elevational view of the light emitting diode according to the embodiment of FIG. 8;
FIG. 12 is a bottom plan view of the light emitting diode according to the embodiment of FIG. 8; and,
FIG. 13 is a rear elevational view of the light emitting diode according to the embodiment of FIG. 8.

1 Claim, 3 Drawing Sheets



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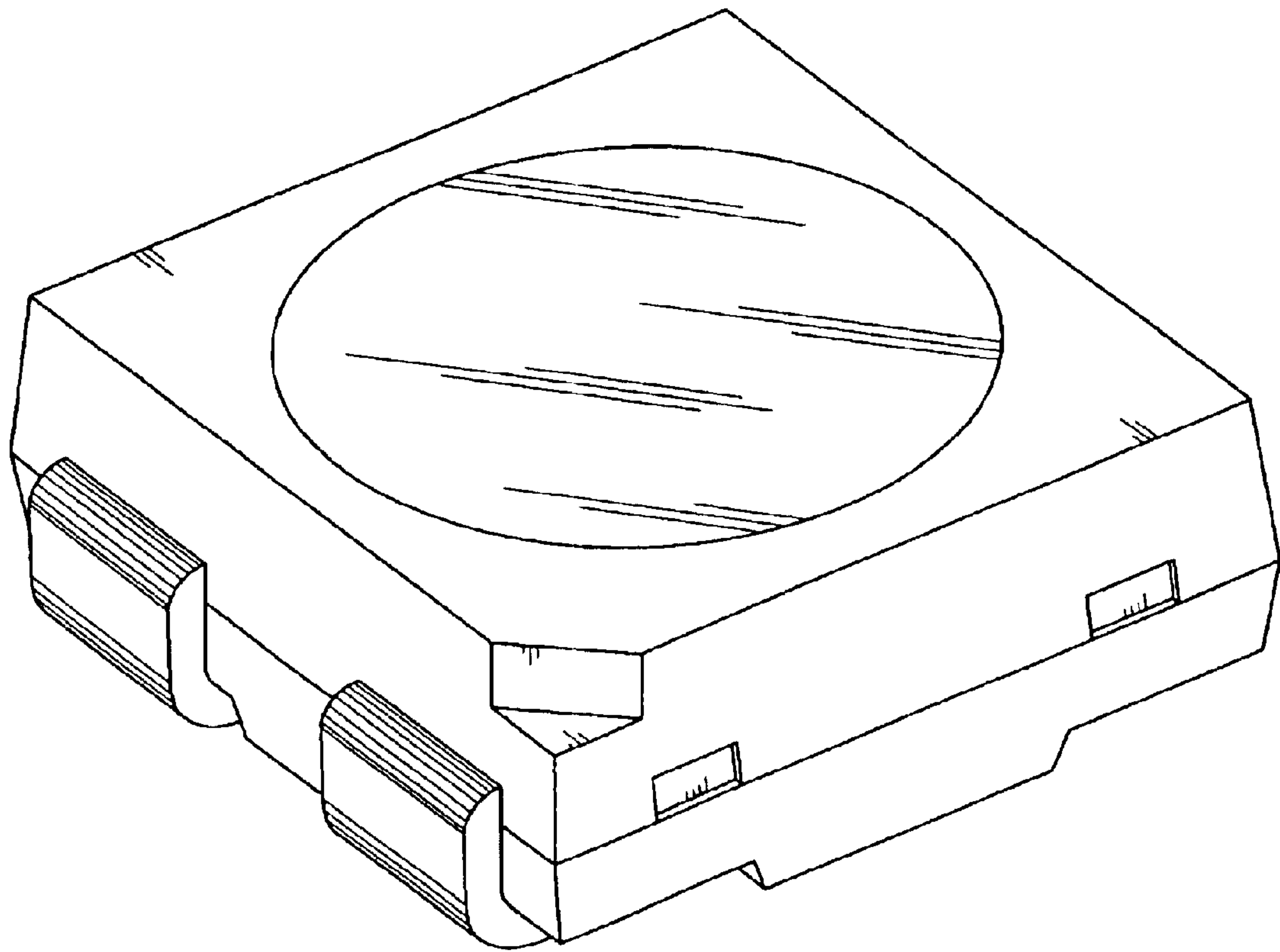


FIG. 1

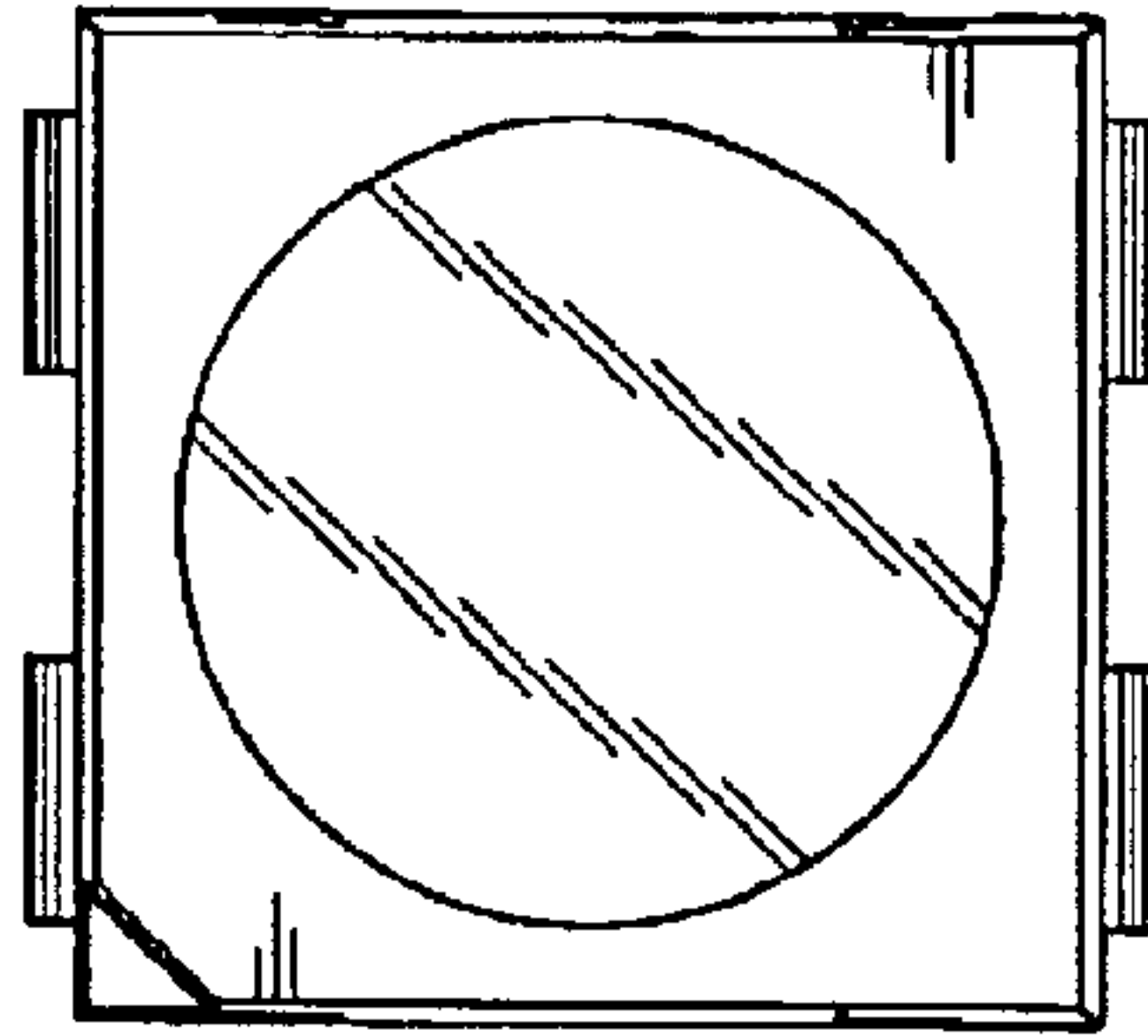


FIG. 2

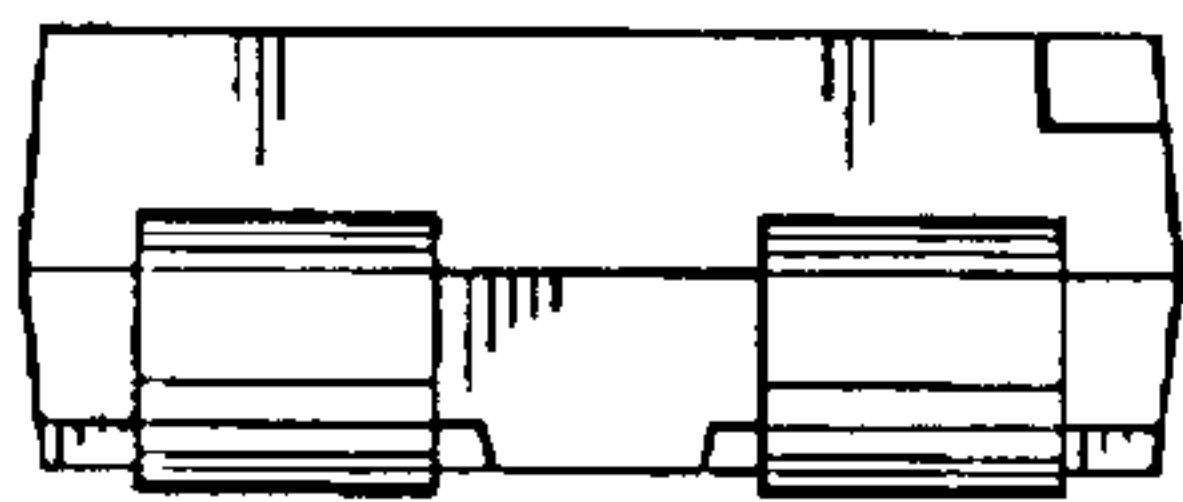


FIG. 3



FIG. 4

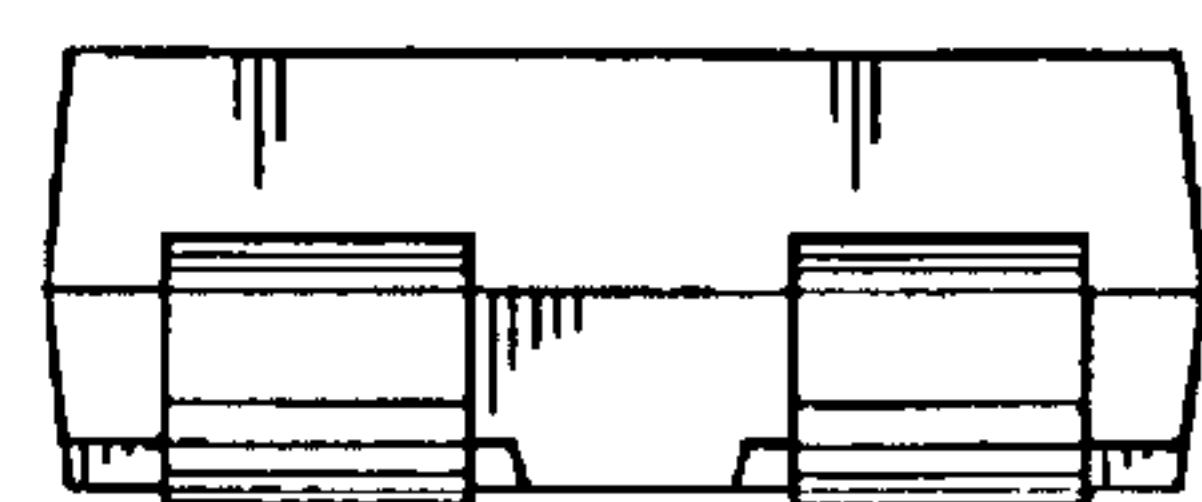


FIG. 5

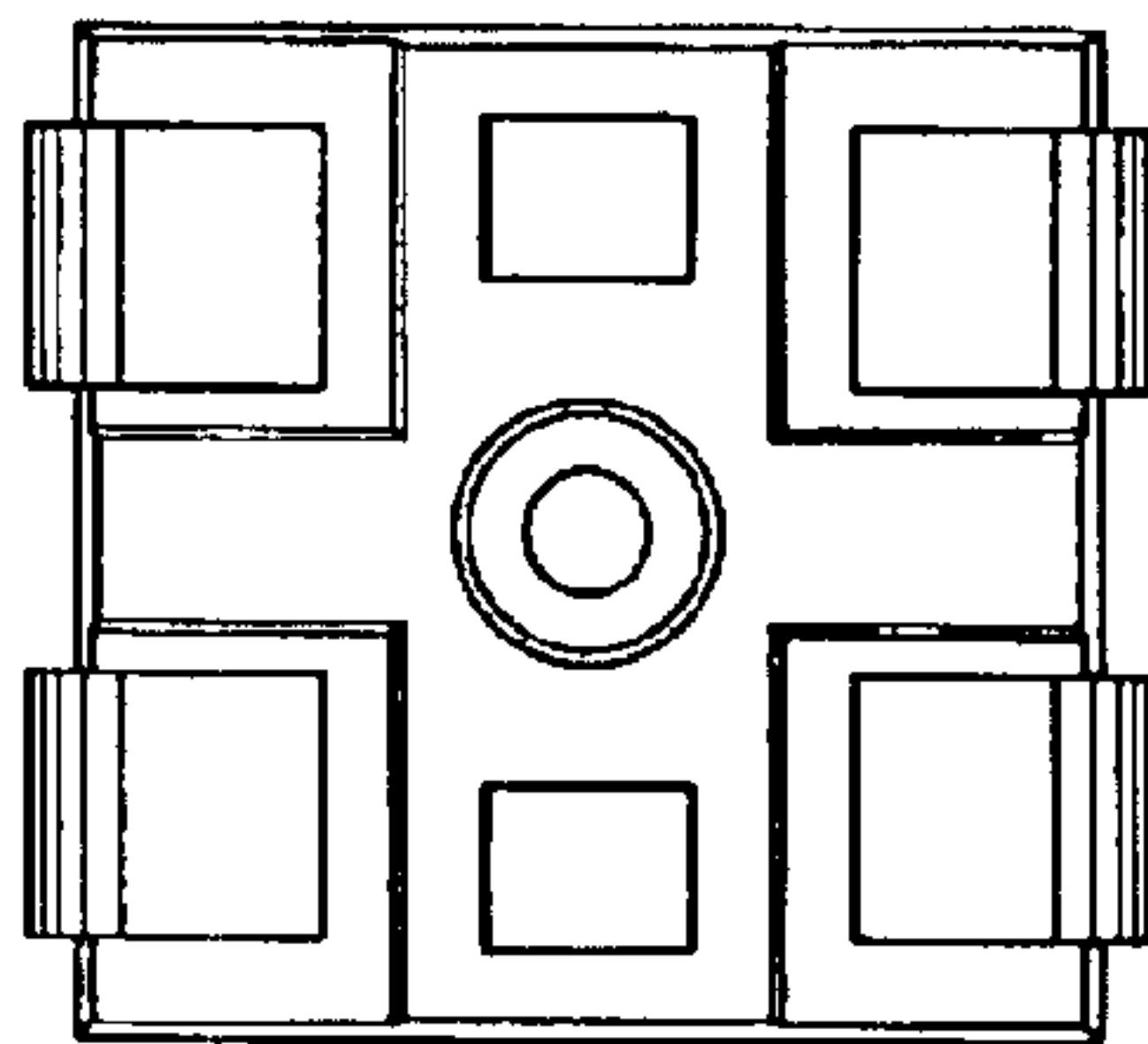


FIG. 6

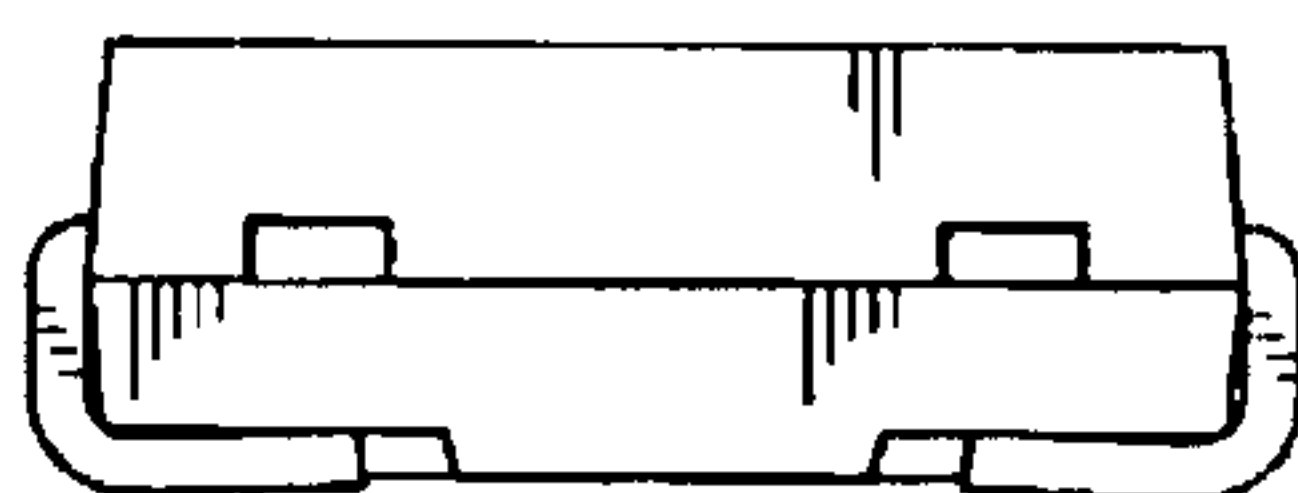


FIG. 7

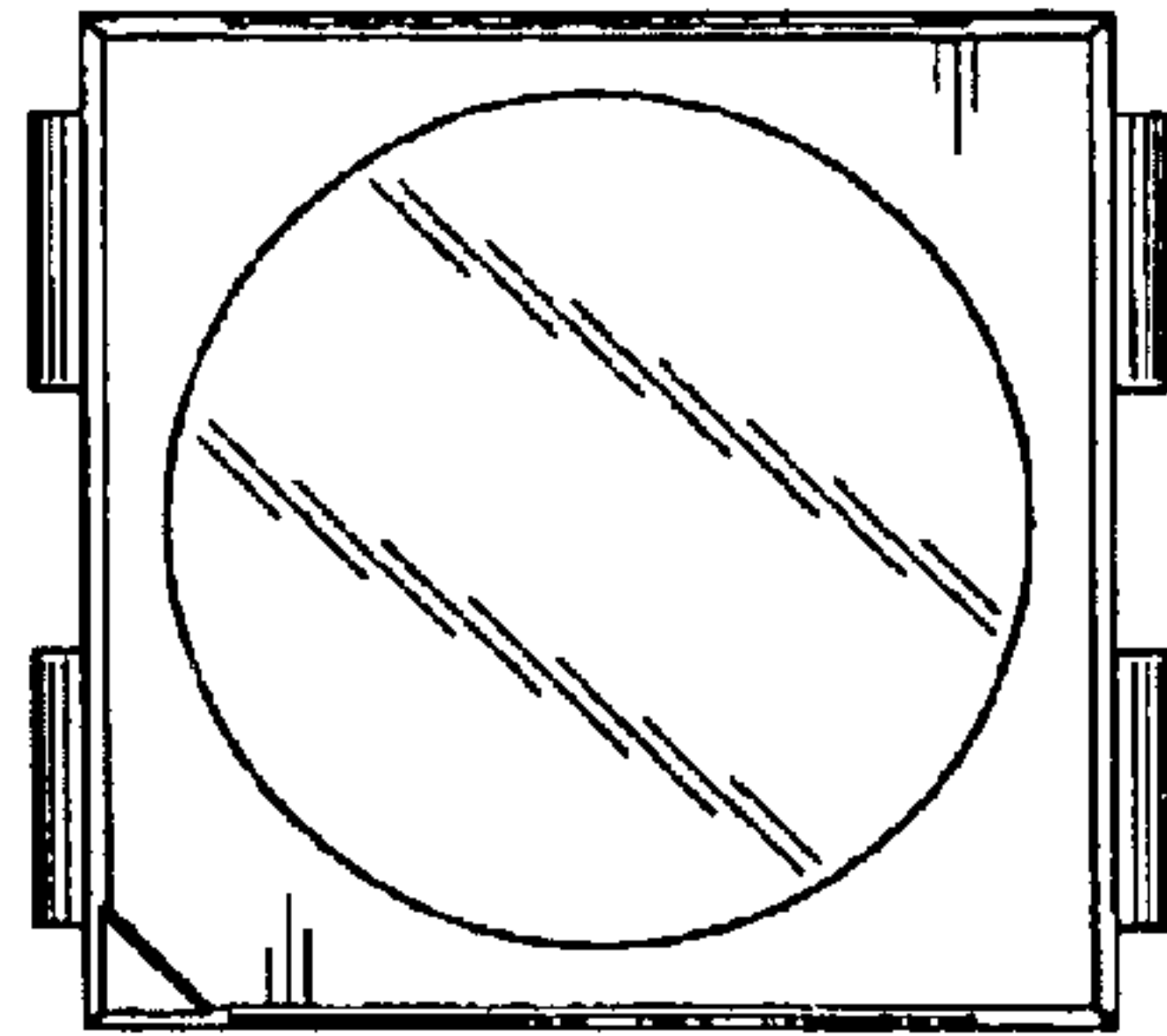


FIG. 8

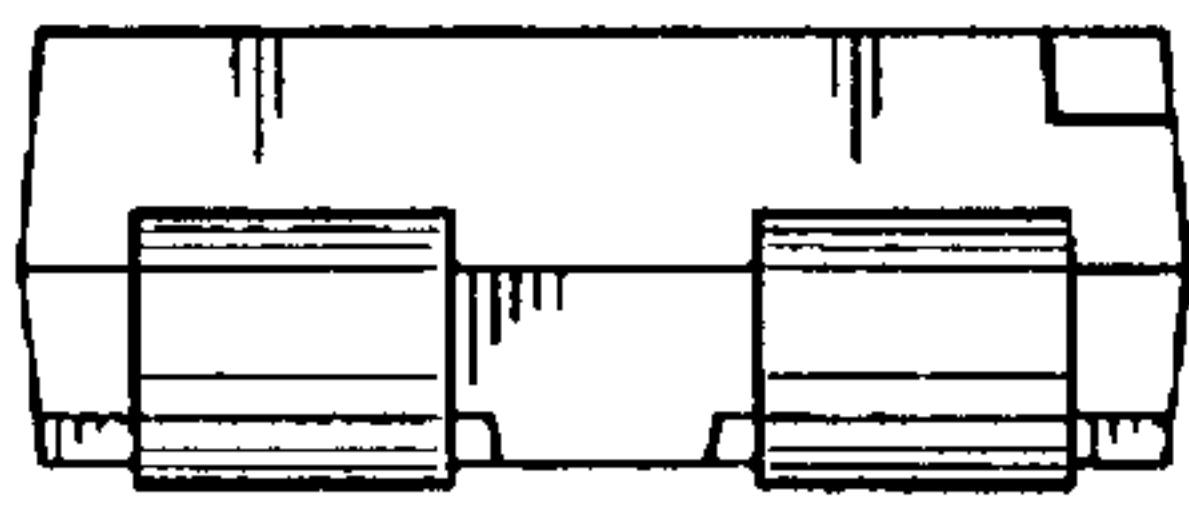


FIG. 9

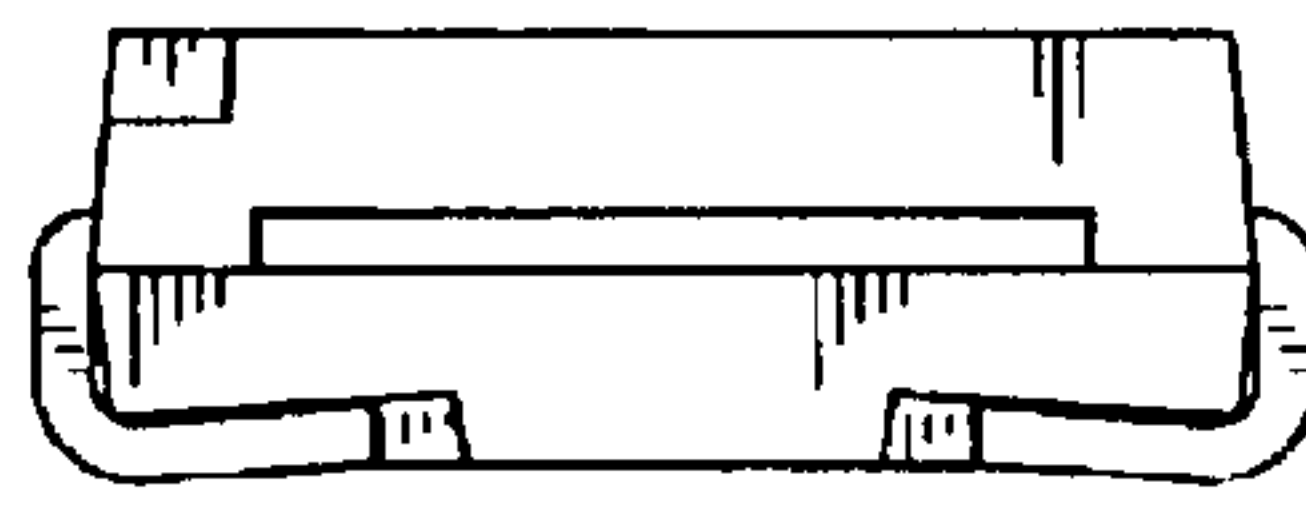


FIG. 10

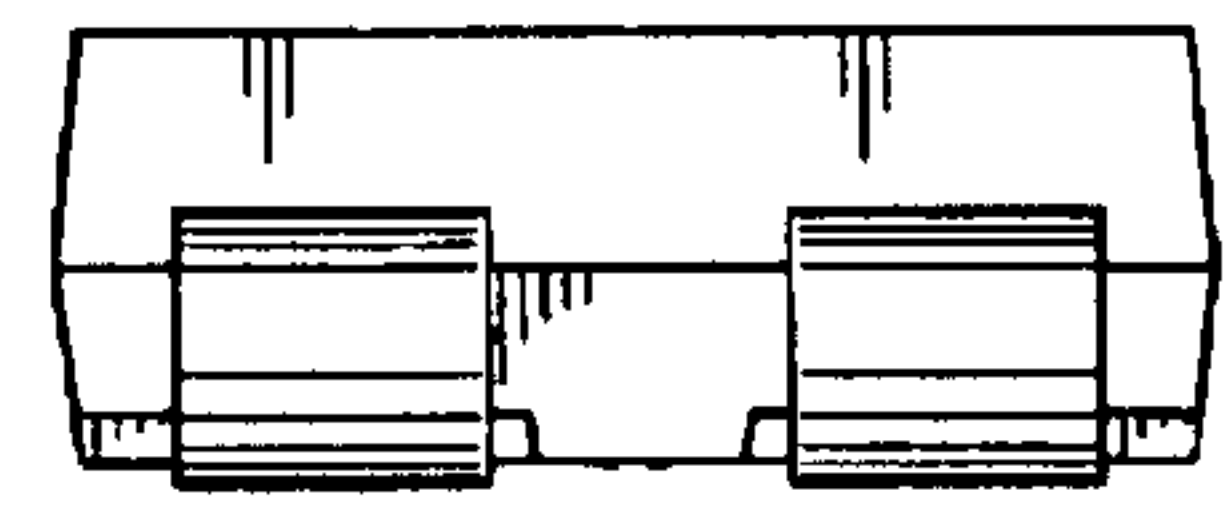


FIG. 11

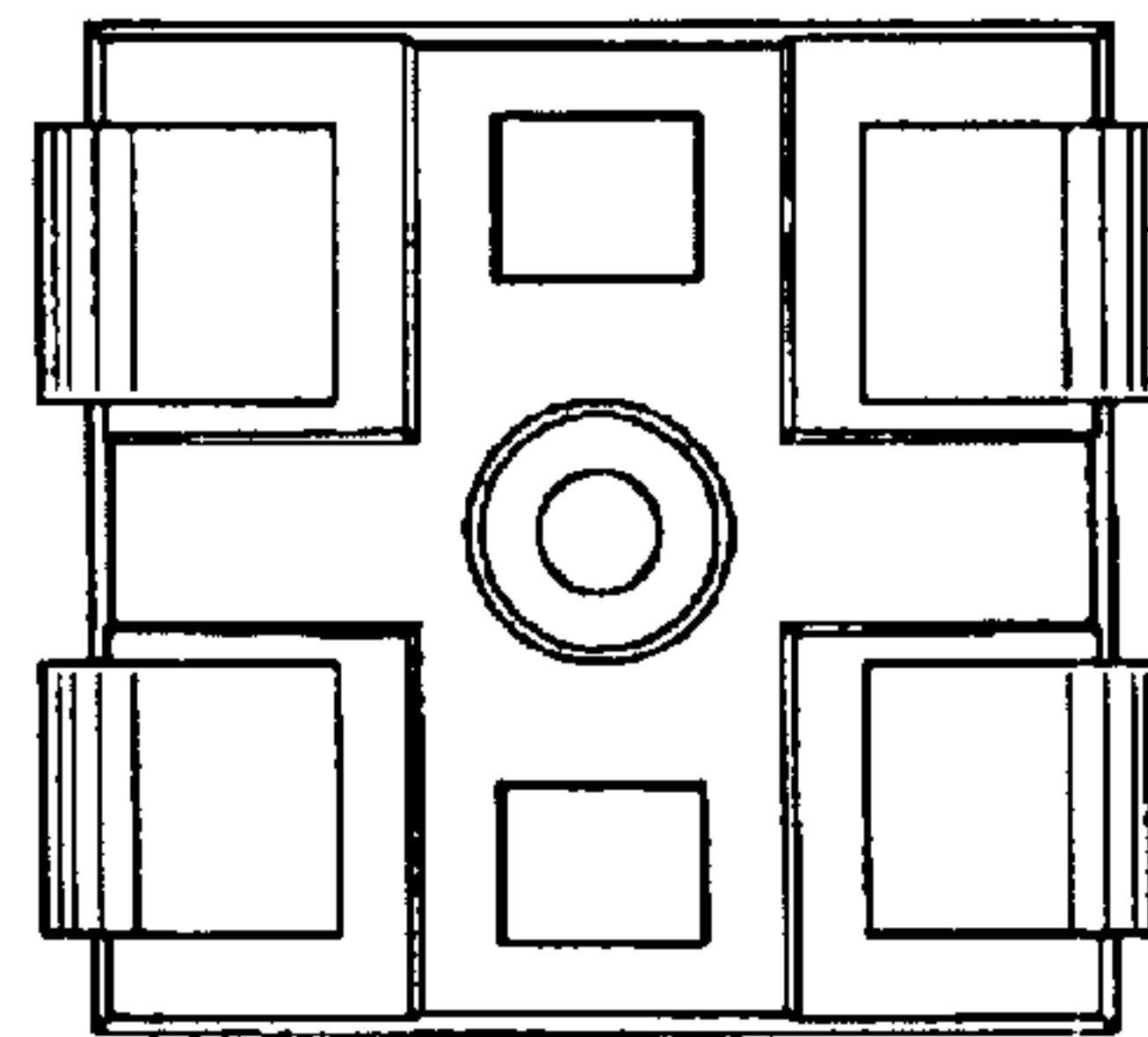


FIG. 12

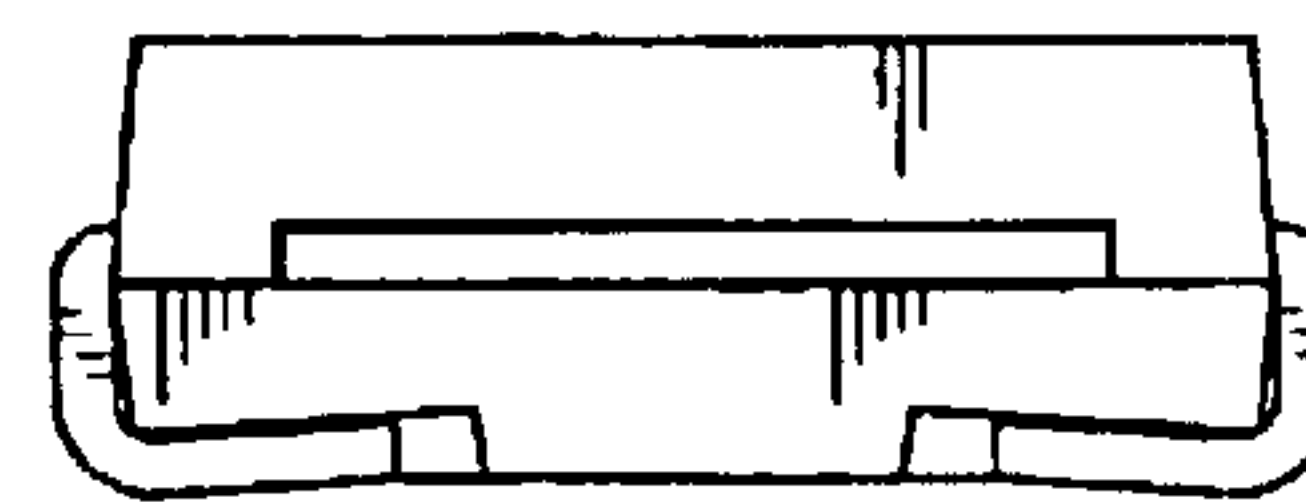


FIG. 13